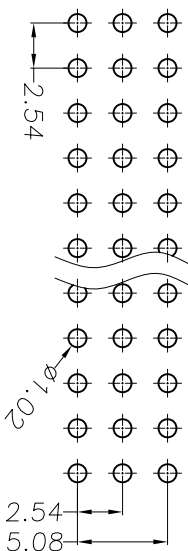
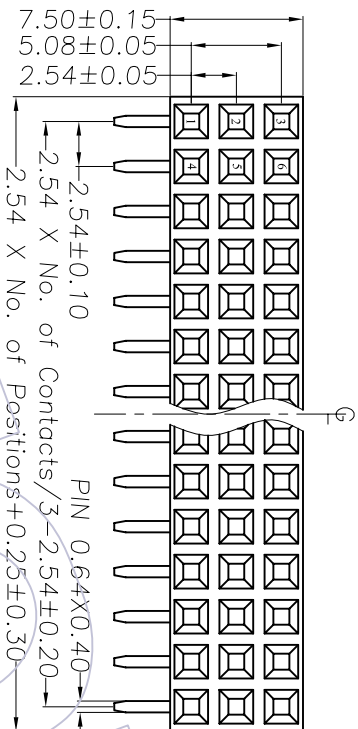


HSP

NOTES:

Current Rating: 3.0AMP
 Withstand Voltage: 500V AC/DC
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩMin
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze or Brass
 Contact plating: Au or Sn over Ni
 Insulator Material: PA6T or PBT+30%G. F UL94V-0

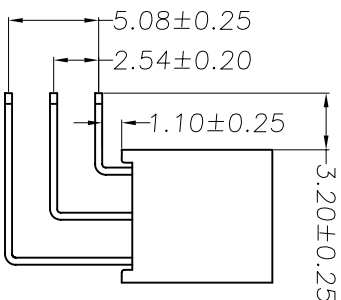
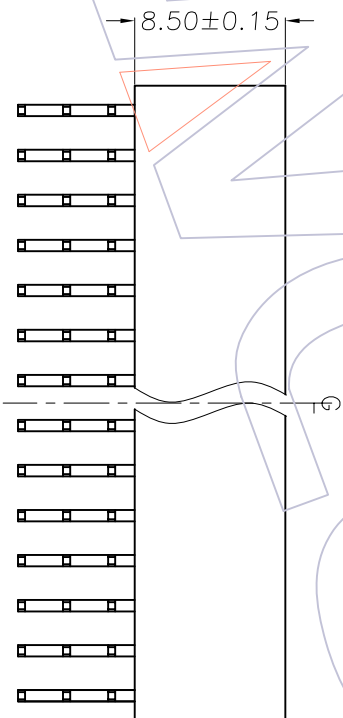


Recommended P.C.B Layout(TOP Side)
 (PCB BOARD TOLERANCE±0.05)

Ordering Information

2185 - 3 XX R XX X YN T 1

No. of Pins per Row: 02-40PIN
 Contact Plating: GP=Gold Flash, A=18T, C=PA6T
 Insulator: T=Tube, A=Tray
 Packing: T=Tube, A=Tray
 G1=5μ"Gold, G2=5μ"Gold, G3=10μ"Gold, G4=15μ"Gold, G5=30μ"Gold, S0=Gold Flash/Tin, S1=3μ"Gold/Tin, S2=5μ"Gold/Tin, S3=10μ"Gold/Tin, S4=15μ"Gold/Tin, S5=30μ"Gold/Tin, SN=Tin



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WEIXD	SCALE	UNIT	PART NO.	TITLE:
A0	08/03/13	NEW			XXX ±0.40 XXX ±0.25 XXX ±0.15	DESIGN CHECK	08.03.13	2.5:1	mm A4	2185-3XXXXXXT1	FL2.54mm THREE ROWS 90° H=8.5
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	Angle DIM	CHECK		PROJ.		Customer NO.	
1					± 3'	APPROVE					

WCON 维峰五金电子有限公司
 WAFE HARDWARE ELECTRONICS CO.,LTD